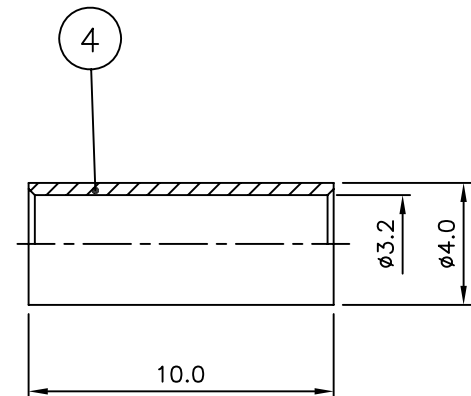
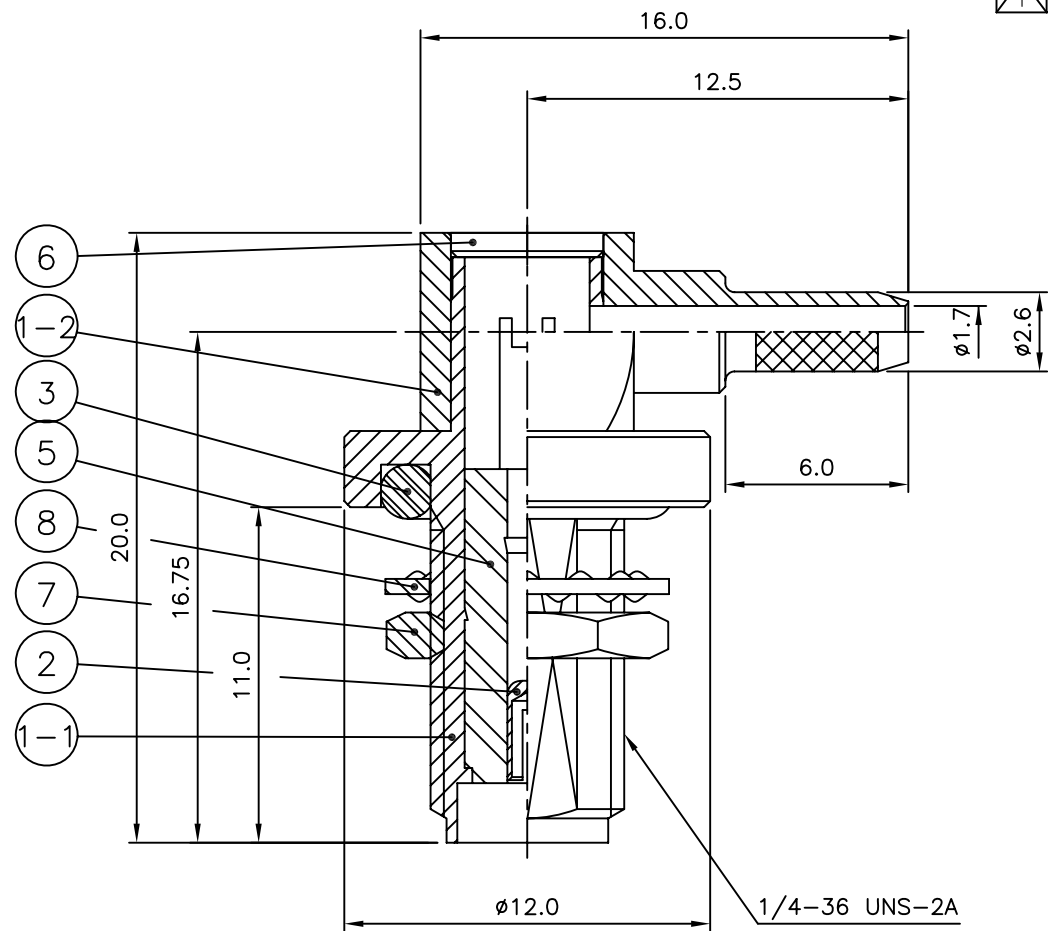


1 2 3 4 5 6

REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	Y.H.CHOI	2011.04.04.
1	[설번 No.201410-0011] 조립성 향상 (커버 변경)	S.M.LEE	I.C.KIM	2014.10.20.



8	WASHER	1	BsS	Nickel Plate	DWA00005-5/3
7	NUT	1	MBsBD	Nickel Plate	DNT00025-5/5
6	COVER	1	MBsBD	Nickel Plate	DCO00026-5/1 DCO00032-5/2
5	INSULATOR	1	TEFLON		DIN00981-N/1
4	FERRULE	1	MBsBD	Nickel Plate	DFE00034-5/1
3	GASKET	1	NBR		DGK00023-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT02421-5/1
1	1-2 BODY	1	MBsBD	Nickel Plate	DBB00290-5/1
	1-1 BODY	1	MBsBD	Nickel Plate	DBD02898-3/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 10. 20.	
	Angle	APPROVED BY I.C.KIM	
MATERIAL	-	CHECKED BY	
		DRAWN BY S.M.LEE	
FINISH	-	SCALE	UNIT
		4/1	mm

KJ COMTECH RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
TITLE SMA50 CABLE JL-BH RG316	
DWG NO.	CN02655-7/1
REVISION	1
SHEET	1 of 1

1 2 3 4 5 6